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- Ultra-Fast Operation . . . 10 ns (typ)
- Low Positive Supply Current 12.7 mA (Typ)
- Operates From a Single 5-V Supply or From a Split ±5-V Supply
- Complementary Outputs
- Input Common-Mode Voltage Includes Negative Rail
- Low Offset Voltage
- No Minimum Slew Rate Requirement
- Output Latch Capability
- Functional Replacement to the LT1116

description

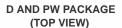
The TL3116 is an ultra-fast comparator designed to interface directly to TTL logic while operating from either a single 5-V power supply or dual ±5-V supplies. The input common-mode voltage extends to the negative rail for ground sensing applications. It features extremely tight offset voltage and high gain for precision applications. It has complementary outputs that can be latched using the LATCH ENABLE terminal. Figure 1 shows the positive supply current of the comparator. The TL3116 only requires 12.7 mA (typical) to achieve a propagation delay of 10 ns.

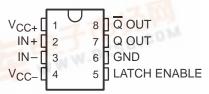
The TL3116 is a pin-for-pin functional replacement for the LT1116 comparator, offering high-speed operation but consuming much less power.

AVAILABLE OPTIONS

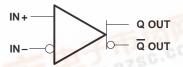
10. 74	PACKAGED	CHIP		
TA	SMALL OUTLINE† (D)	TSSOP (PW)	FORM‡ (Y)	
0°C to 70°C	TL3116CD	TL3116CPWLE	TL3116Y	
-40°C to 85°C	TL3116ID	TL3116IPWLE	-	

† The PW packages are available left-ended taped and reeled only.



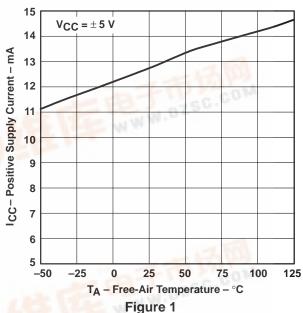


symbol (each comparator)



POSITIVE SUPPLY CURRENT

FREE-AIR TEMPERATURE

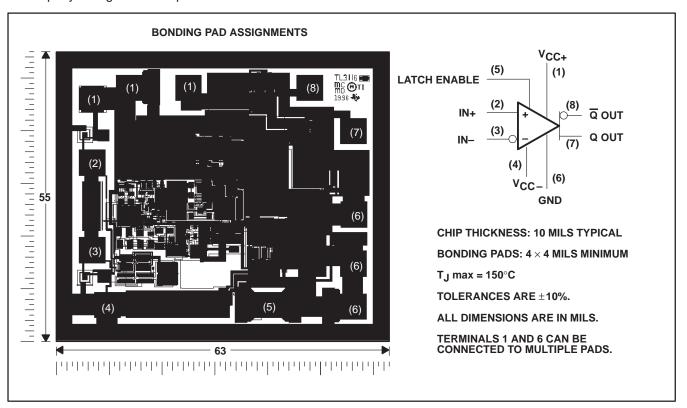


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

[‡] Chip forms are tested at $T_A = 25^{\circ}$ C only.

TL3116Y chip information

This chip, when properly assembled, displays characteristics similar to the TL3116C. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. Chips may be mounted with conductive epoxy or a gold-silicon preform.



COMPONENT COUNT					
Bipolars	53				
MOSFETs	49				
Resistors	46				
Capacitors	14				



TL3116, TL3116Y ULTRA-FAST LOW-POWER PRECISION COMPARATORS SLCS132B – MARCH 1997 – REVISED APRIL 1997

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{DD} (see Note 1)	7 \/ to 7 \/
, ,	
Differential input voltage, V _{ID} (see Note 2)	7 V
Input voltage range, V _I	
Input voltage, V _I (LATCH ENABLE)	
Output current, I _O	
Continuous total power dissipation	
Operating free-air temperature range, T _A	–40°C to 85°C
Storage temperature range, T _{stg}	– 65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to network ground.

2. Differential voltages are at IN+ with respect to IN-.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{$A$}} \leq 25^{\circ}\mbox{$C$}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING		
D	725 mW	5.8 mW/°C	464 mW		
PW	525 mW	4.2 mW/°C	336 mW		



TL3116, TL3116Y ULTRA-FAST LOW-POWER PRECISION COMPARATORS SLCS132B - MARCH 1997 - REVISED APRIL 1997

electrical characteristics at specified operating free-air temperature, V_{DD} = ± 5 V, V_{LE} = 0 (unless otherwise noted)

DADAMETED	TEST CONDITIONS!		TL3116C			TL3116I		UNIT
PARAMETER	TEST CONDITIONS!	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
Input offeet voltage	T _A = 25°C		0.5	3		0.5	3	mV
input onset voltage	T _A = full range			3.5			3.5	IIIV
Temperature coefficient of input offset voltage			-2.5			-2.8		μV/°C
Innut offeet ourrent	T _A = 25°C		0.1	0.2		0.1	0.2	
input onset current	T _A = full range			0.3			0.35	μΑ
Input bigg gurrent	T _A = 25°C		0.7	1.1		0.7	1.1	
input bias current	T _A = full range			1.2			1.5	μΑ
Common-mode input	V _{DD} = ±5 V	-5		2.5	-5		2.5	V
voltage range	V _{DD} = 5 V	0		2.5	0		2.5	V
Common-mode rejection ratio	-5 ≤ V _{IC} ≤ 2.5 V	75	100		75	100		dB
k _{SVR} Supply-voltage rejection	Positive supply: $4.6 \text{ V} \le +\text{V}_{DD} \le 5.4 \text{ V}$, $T_A = 25^{\circ}\text{C}$	60	80		60	80		dB
ratio	Negative supply: $-7 \text{ V} \le -\text{V}_{DD} \le -2 \text{ V}$, $T_A = 25^{\circ}\text{C}$	80	100		80	100		αь
Low lovel output voltage	$I_{(sink)} = 4 \text{ mA},$ $V+ \le 4.6 \text{ V},$ $T_A = 25^{\circ}\text{C}$		400	600		400	600	mV
Low-level output voltage	$I_{(sink)}$ = 10 mA, V+ \leq 4.6 V, T_A = 25°C		750			750		IIIV
OH High-level output voltage	$V+ \le 4.6 \text{ V},$ $I_O = 1 \text{ mA},$ $T_A = 25^{\circ}\text{C}$	3.6	3.9		3.6	3.9		V
riign-ievei output voitage	$V+ \leq 4.6 \text{ V}, \\ T_A = 25^{\circ}\text{C}$ $I_O = 10 \text{ mA},$	3.4	3.8		3.4	3.8		V
Positive supply current	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	12.7	15	mA				
Negative supply current	TA = ruii range	-2.6			-3			IIIA
Low-level input voltage (LATCH ENABLE)				0.8			0.8	V
High-level input voltage (LATCH ENABLE)		2			2			V
Low-level input current	V _{LE} = 0		0	1		0	1	μΑ
(LATCH ENABLE)	V _{LE} = 2 V		24	39		24	45	μΑ
	of input offset voltage Input offset current Input bias current Common-mode input voltage range Common-mode rejection ratio Supply-voltage rejection ratio Low-level output voltage High-level output voltage Positive supply current Negative supply current Low-level input voltage (LATCH ENABLE) High-level input voltage (LATCH ENABLE) Low-level input current	Input offset voltage	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{ c c c c c c c c } \hline PARAMETER & TEST CONDITIONS T & MIN & TYP$ & MAX & MIN & TYP$ \\ \hline Input offset voltage & & & & & & & & & & & & & & & & & & &$	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$

[†] Full range for the TL3116C is $T_A = 0^{\circ}$ C to 70° C. Full range for the TL3116I is $T_A = -40^{\circ}$ C to 85° C. ‡ All typical values are measures with $T_A = 25^{\circ}$ C.

switching characteristics, V_{DD} = ± 5 V, V_{LE} = 0

PARAMETER		TEST CONDITIONS†		TL3116C		TL3116I		UNIT		
				MIN	TYP	MAX	MIN	TYP	MAX	UNII
^t pd1 Propagation delay time [‡]	$\Delta V_{I} = 100 \text{ mV},$	T _A = 25°C		9.9	12		9.9	12		
	$V_{OD} = 5 \text{ mV}$	T _A = full range		9.9	14		9.9	15	ns	
	$\Delta V_I = 100 \text{ mV},$ $V_{OD} = 20 \text{ mV}$	T _A = 25°C		8.2	10.3		8.2	10.3		
		T _A = full range		8.2	12.7		8.2	13.7		
t _{sk(p)}	Pulse skew (t _{pd+} - t _{pd-})	$\Delta V_I = 100 \text{ mV},$ $T_A = 25^{\circ}\text{C}$	$V_{OD} = 5 \text{ mV},$		0.5			0.5		ns
t _{su}	Setup time, LATCH ENABLE				3.4			3.4		ns

[†] Full range for the TL3116C is 0°C to 70°C. Full range for the TL3116I is –40°C to 85°C.

TYPICAL CHARACTERISTICS

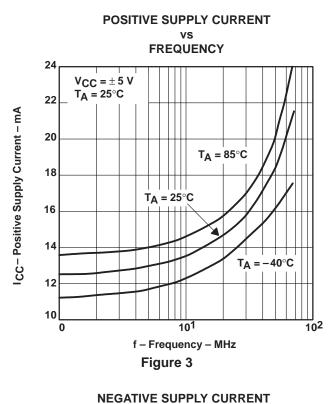
Table of Graphs

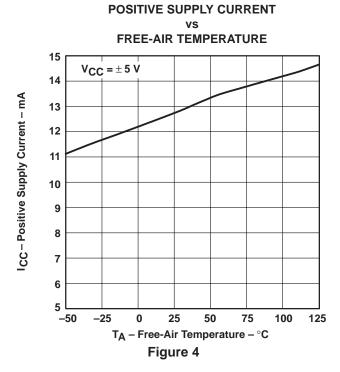
			FIGURE
		vs Input voltage	2
ICC	Positive supply current	vs Frequency	3
		vs Free-air temperature	4
ICC	Negative supply current	vs Free-air temperature	5
		vs Overdrive voltage	6
^t pd	Propagation delay time	vs Supply voltage	7
		vs Input impedance	8
		vs Load capacitance	9
		vs Free-air temperature	10
VIC	Common-mode input voltage	vs Free-air temperature	11
V _{IT}	Input threshold voltage (LATCH ENABLE)	vs Free-air temperature	12
\/-	Output valtage	vs Output source current	13
VO	Output voltage	vs Output sink current	14
Ι _Ι	Input current (LATCH ENABLE)	vs Input voltage	15

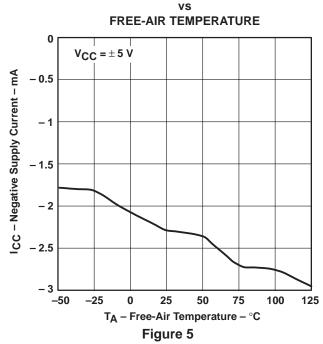


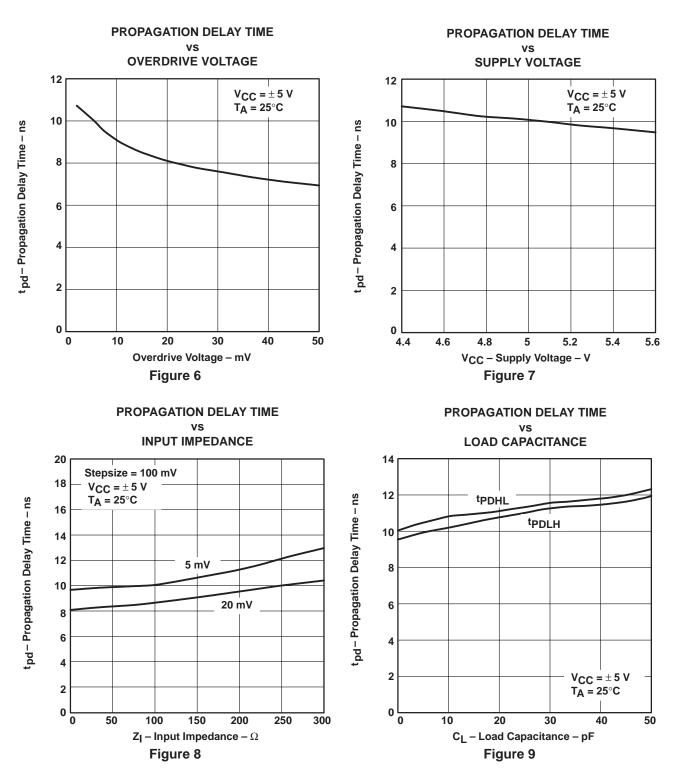
[‡] t_{pd1} cannot be measured in automatic handling equipment with low values of overdrive. The TL3116 is 100% tested with a 1-V step and 500-mV overdrive at T_A = 25°C only. Correlation tests have shown that t_{pd1} limits given can be ensured with this test, if additional dc tests are performed to ensure that all internal bias conditions are correct. For low overdrive conditions, V_{OS} is added to the overdrive.

POSITIVE SUPPLY CURRENT vs **INPUT VOLTAGE** 20 $V_{CC} = \pm 5 V$ 18 T_A = 25°C ICC - Positive Supply Current - mA 16 14 T_A = 85°C 12 T_A = 25°C 10 T_A = −40°C 8 6 4 2 0 2 8 1 V_I - Input Voltage - V Figure 2

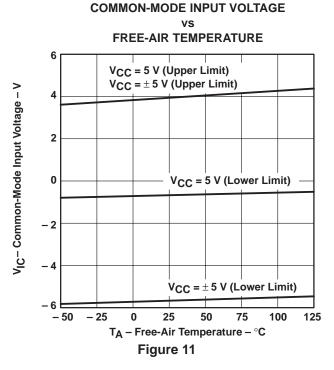


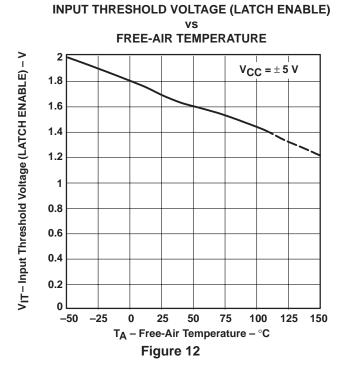


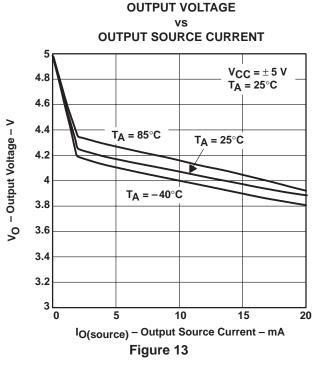




PROPAGATION DELAY TIME FREE-AIR TEMPERATURE 25 $V_{CC} = \pm 5 V$ t pd - Propagation Delay Time - ns 20 15 **Rising Edge** 10 Falling Edge 5 25 - 50 - 25 75 100 125 T_A - Free-Air Temperature - °C Figure 10

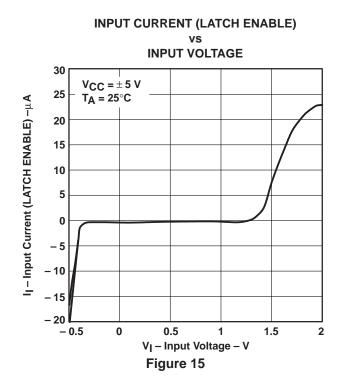








OUTPUT VOLTAGE OUTPUT SINK CURRENT $V_{CC} = \pm 5 V$ $T_A = 25^{\circ}C$ 1.8 1.6 V_O - Output Voltage - V 1.4 1.2 T_A = 25°C $T_A = -40^{\circ}C$ 0.8 T_A = 85°C 0.6 0.4 0.2 10 20 I_{O(sink)} – Output Sink Current – mA Figure 14



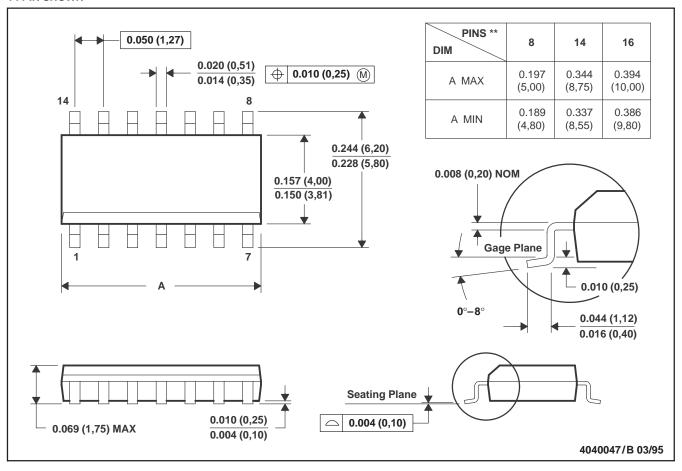
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MECHANICAL INFORMATION

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PIN SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
- D. Four center pins are connected to die mount pad.
- E. Falls within JEDEC MS-012

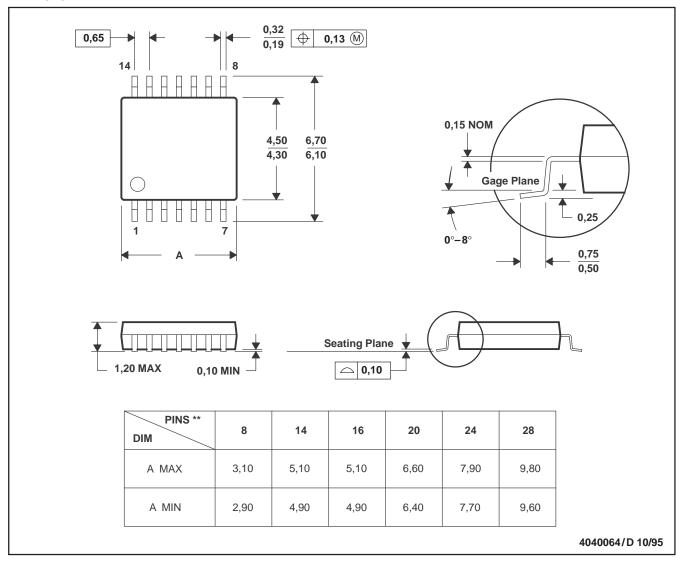


MECHANICAL INFORMATION

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PIN SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153



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